

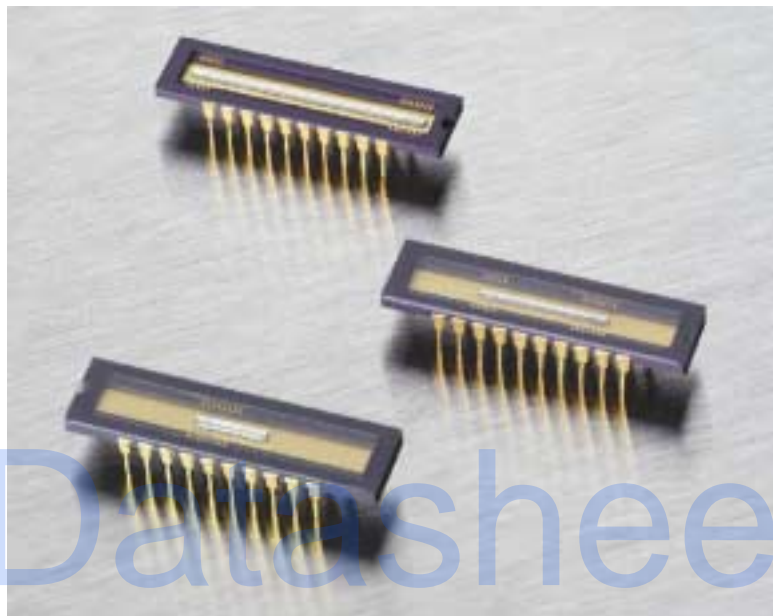
Imaging

CCD

**RETICON®**

# P-Series Linear Photodiode Array Imagers

14µm, single output, 512, 1024, 2048 elements



## Description

In the P-series linear imager, PerkinElmer has combined the best features of high-sensitivity photodiode array detection and high-speed charge-coupled scanning to offer an uncompromising solution to the increasing demands of advanced imaging applications.

These high performance imagers feature low noise, high sensitivity, impressive charge storage capacity, and lag-free dynamic imaging in a convenient single-output architecture. The 14µm square contiguous pixels in these imagers reproduce images with minimum information loss and artifact generation, while their unique photodiode structure provides excellent blue response extending below 250nm and into the ultraviolet.

The two-phase CCD readout register requires only 5 volts for clocking yet achieves excellent charge transfer efficiency. Additional electrodes provide independent control of exposure and antiblooming. Finally, the high-sensitivity readout amplifier provides a large output signal to relax noise requirements on the camera electronics that follow.

Available in standard array lengths of 512, 1024, and 2048 elements with either glass or UV-enhanced fused silica windows, these versatile imagers are widely used in high-speed document reading, web inspection, mail sorting, production measurement and gauging, position sensing, spectroscopy, and other industrial and scientific applications requiring peak imager performance.

Note: While the P-Series imagers have been designed to resist electrostatic discharge (ESD), they can be damaged from such discharges. Always observe proper ESD precautions when handling and storing this imager.

## Features

- Extended spectral range--200 to 1000 nm
- 40 MHz pixel readout rate with line rates to 70 kHz
- >2500:1 dynamic range
- 5-volt clocking
- 14µm square pixels with 100% fill factor
- Ultra low image lag
- Electronic exposure and antiblooming controls



# Linear Photodiode Array Imagers

## Description (cont.)

P-series imagers combine high-performance photodiodes with high speed CCD readout registers and a high-sensitivity readout amplifier. Refer to Figure 1 for construction details.

## Light Detection Area

The light detection area in P-series imagers is a linear array of contiguous pinned photodiodes on 14  $\mu\text{m}$  centers. These photodiodes are constructed using PerkinElmer's advanced photodiode design that extends short-wavelength sensitivity into the deep UV below 250 nm, while preserving 100% fill factor and delivering extremely low image lag. This unique design also avoids polysilicon layers in the light detection area that reduces the quantum efficiency of most CCD imagers. The P-series imagers are supplied with glass windows for general visible use, or fused silica windows for use in the UV below 250nm. On a custom basis, P-series imagers can be supplied without an affixed window. See Figures 2a and 2b for sensitivity and window transmission curves.

For lowest lag, all P-series imagers feature pinned photodiodes. Pinning, which requires a special semiconductor process step, provides a uniform internal voltage reference for the charge stored in every photodiode. This stable reference assures that every photodiode is fully discharges after every scan.

Photodiodes covered with light shields included at one or both ends of the imager provide a dark current reference for clamping. These are separated from the active photodiodes by two unshielded transition pixels that assure uniform response out to the last active photodiode.

Figure 2a. Spectral Sensitivity Curve

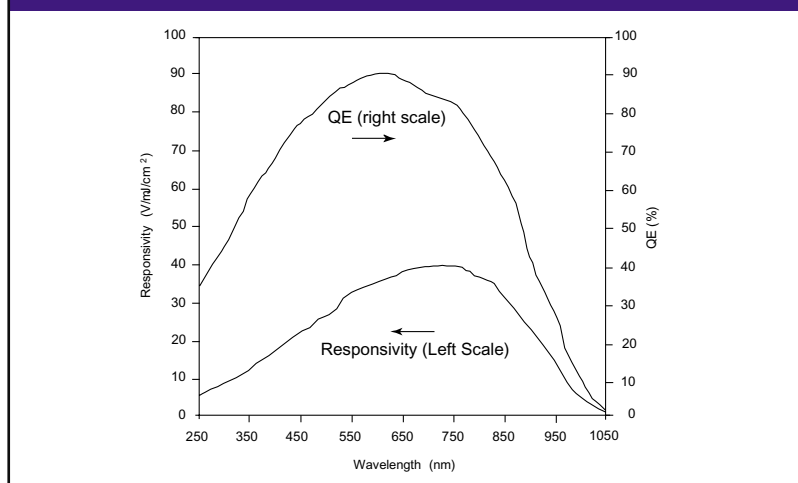


Figure 2b. Window Transmission Curve

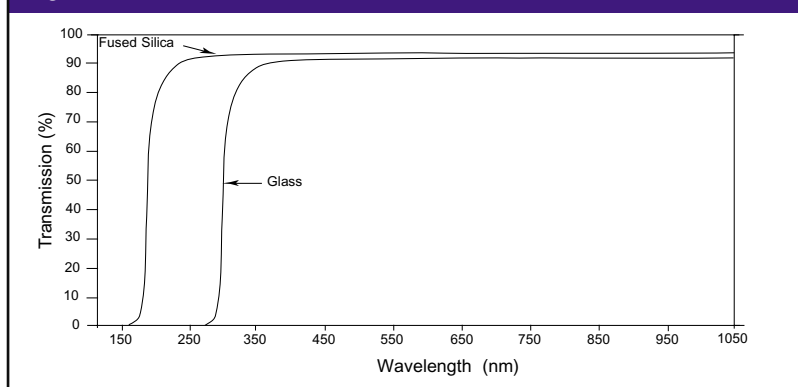
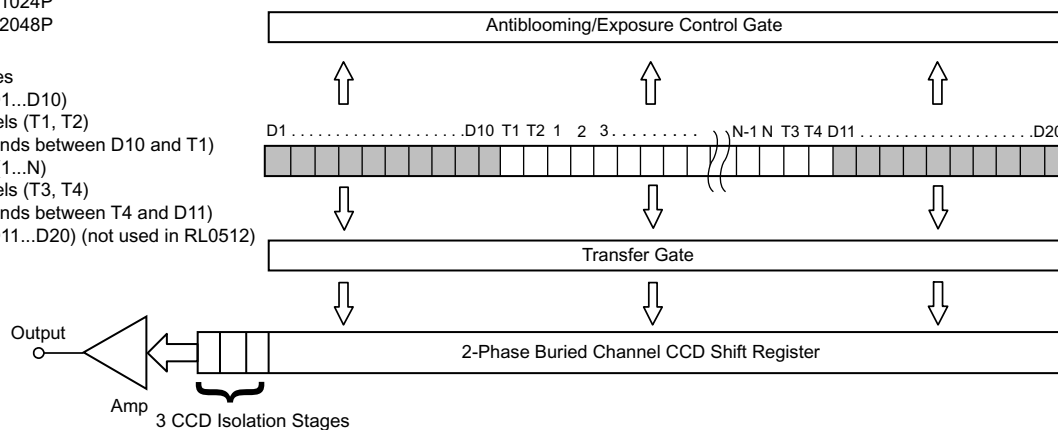


Figure 1. Imager Functional Diagram

N = 512 for the RL0512  
N = 1024 for the RL1024P  
N = 2048 for the RL2048P

- 3 Isolation stages
- 10 Dark pixels (D1...D10)
- 2 Transition pixels (T1, T2)  
(Light shield ends between D10 and T1)
- N Active Pixels (1...N)
- 2 Transition pixels (T3, T4)  
(Light shield ends between T4 and D11)
- 10 Dark pixels (D11...D20) (not used in RL0512)



# Linear Photodiode Array Imagers

## Light Detection Area (cont)

Due to the potential for light leakage, the two dark pixels nearest the transition pixels should not be used as a dark reference.

## Horizontal Shift Registers

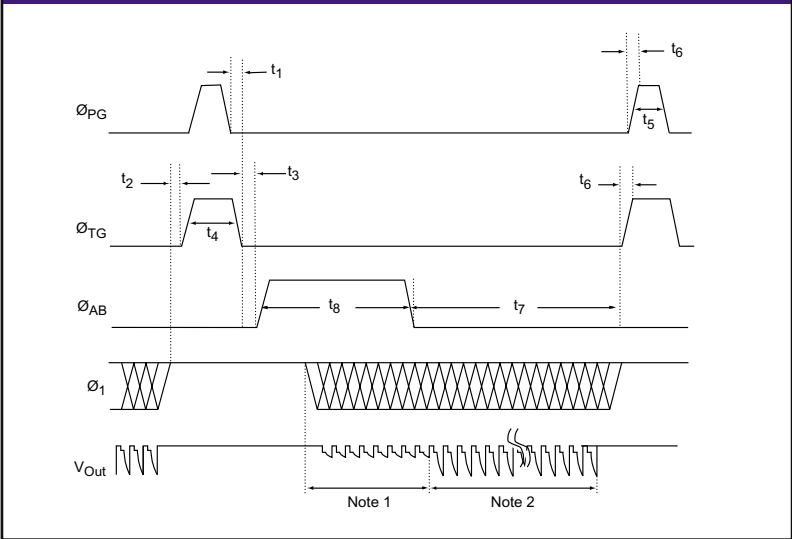
Charge packets collected in the photodiodes as light is received are converted to a serialized output stream through a buried channel, two-phase CCD shift register that provides high charge transfer efficiency at shift frequencies up to 40 MHz. The PerkinElmer 5-volt CCD process used in this design enables low-power, high-speed operation with inexpensive, readily-available driver devices.

The transfer gate ( $\phi_{TG}$ ) controls the movement of charge packets from the photodiodes to the CCD shift register. During charge integration, the voltage controlling the  $\phi_{TG}$  is held in its low state to isolate the photodiodes from the shift register. When transfer of charge to the shift register is desired,  $\phi_{TG}$  is switched to its high state to create a transfer channel between the photodiodes and the shift register. The charge transfer sequence, detailed in Figure 4, proceeds as follows:

After readout of a particular image line (n), the shift register is empty of charge and ready to accept new charge packets from the photodiode representing image line n+1. To begin the transfer sequence, the horizontal clock pulses ( $\phi_{H1}$  and  $\phi_{H2}$ ) are stopped with  $\phi_{H1}$  held in its high state, and  $\phi_{H2}$  in its low state.  $\phi_{TG}$  is then switched high to start the transfer of charge to the shift register. Once the  $\phi_{TG}$  reaches its high state, the photo gate voltage ( $\phi_{PG}$ ) is set to high to complete the transfer. It is recommended that the photo gate voltage be held in the high state for at least 0.1  $\mu$ s to ensure complete transfer. After this interval, the photo gate voltage is returned to its low state, and when this is completed, the transfer gate is also returned to its low state. The details of the transfer timing are shown in Figure 3 with ranges and tolerances in Table 1.

After transfer, the charge is transported along the shift register by the alternate action of two horizontal phase voltages  $\phi_{H1}$  and  $\phi_{H2}$ . While the two-phase CCD shift register architecture allows relaxed timing tolerances over those required in three or four-phase, optimum charge transfer efficiency (CTE) and lowest power dissipation is obtained when the overlap of the two-phase CCD clocks occurs around the 50% transition level. Additionally, the phase difference between signals  $\phi_{H1}$  and  $\phi_{H2}$  should be maintained near 180° and the duty cycle should be set near to 50% to prevent loss of full well charge storage capacity and charge transfer efficiency.

Figure 3. Transfer Timing Diagram



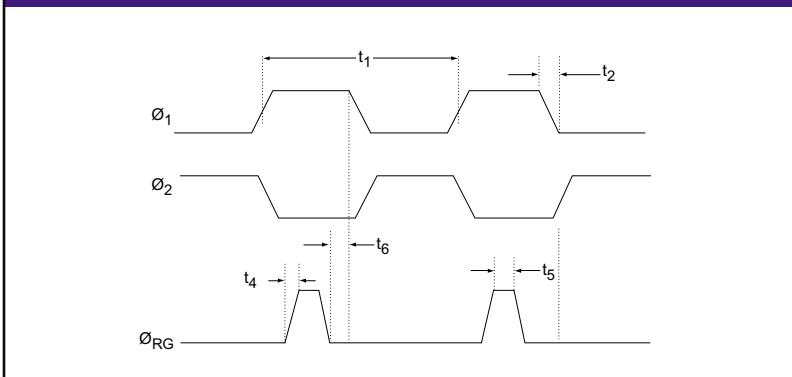
Notes:  
1. Transition and dark pixels  
2. Active Pixels

Table 1. Transfer Timing Requirements

Item	Sym	Min	Typ	Max
Delay of $\phi_{TG}$ falling edge from $\phi_{PG}$ falling edge	$t_1$	5 ns	20 ns	-
Delay of $\phi_{TG}$ rising edge from end of $\phi_{H1}$ and $\phi_{H2}$ clocks	$t_2$	0 ns	10 ns	-
Delay of $\phi_{AB}$ rising edge from $\phi_{PG}$ falling edge	$t_3$	5 ns	5 ns	-
$\phi_{TG}$ pulse width	$t_4$	100 ns	500 ns	-
$\phi_{PG}$ pulse width	$t_5$	100 ns	400 ns	-
Rise/fall time	$t_6$	10 ns	20 ns	-
Integration time	$t_7$	0 ns	-	-
$\phi_{AB}$ pulse width	$t_8$	-	750 ns <sup>1</sup>	-

Note 1: 750 ns is the typical time to fully reset the photodiode

Figure 4. Readout Timing Waveforms



# Linear Photodiode Array Imagers

## Horizontal Shift Registers (cont.)

Readout timing details are shown in Figure 4 with ranges and tolerances in Table 2.

## Timing Requirements

In high-speed applications, fast waveform transitions allow maximum settling time of the output signal. However, it is generally advisable to use the slowest rise and fall times consistent with required video performance because fast edges tend to introduce more transition noise into the video waveform. When the highest speeds are required, careful smoothing of the waveform transitions may improve the balance between speed and video quality.

## Output Amplifier

Charge emerging from the last stage of the shift register is converted to a voltage signal by a charge integrator and video amplifier. The integrator, a capacitor created by a floating diffusion, is initially set to a DC reference voltage (VRD) by setting the reset transistor voltage ( $\phi_{RG}$ ) to its high state. To read out the charge,  $\phi_{RG}$  is pulsed low turning the reset transistor off and isolating the integrator from VRD. The next time  $\phi_{H1}$  goes low, the charge packet is transferred to the integrator, where it generates a voltage proportional to the packet size. The reset transistor voltage,  $\phi_{RG}$ , must reach its low state prior to the high-to-low transition of  $\phi_{H1}$ . An apparent clipping of the video signal will result if this condition is not satisfied. Figure 4 details the clock waveform requirements and overlap tolerances.

The video amplifier buffers the signal from the integrator for output from the imager. Care must be taken to keep the load on this amplifier within its ability to drive highly reactive or low impedance loads. The half power bandwidth into an external load of 10 pF is 150 MHz. It is recommended that the output video signal be buffered with a wide bandwidth follower or other appropriate amplifier to provide a large  $Z_{in}$  to the output amplifier.

Keep the external amplifier close to the output pins to minimize stray inductive and capacitive coupling of the output signal that can harm signal quality.

Table 2. Readout Timing Requirements

Item	Sym	Min	Typ	Max
$\phi_{H1}$ , $\phi_{H2}$ clock period	$t_1$	25 ns	-	-
$\phi_{H1}$ , $\phi_{H2}$ rise/fall time	$t_2$	-	5 ns	-
$\phi_{RG}$ rise/fall time	$t_4$	-	5 ns	-
$\phi_{RG}$ clock - high duration	$t_5$	5 ns	-	-
Delay of $\phi_{H1}$ high -low transition from $\phi_{RG}$ low	$t_6$	0 ns	-	-

Note: The cross over point for  $\phi_{H1}$  and  $\phi_{H2}$  clock transitions should occur within the 10 - 90% level of the clock amplitude.

Table 3. Imager Performance (typical)

Pixel count	512 elements (RL0512P) 1024 elements (RL1024P) 2048 elements (RL2048P)
Pixel size	14 $\mu\text{m} \times 14 \mu\text{m}$
Exposure control	yes
Horizontal clocking	2 $\phi$ (5V clock amplitude)
Number of outputs	1
Dynamic range <sup>1</sup>	>2500:1
Readout noise (rms)	
amplifier	18 electrons
reset transistor	45 electrons
total noise without CDS	50 electrons
Saturation exposure <sup>2</sup>	27 nJ/cm <sup>2</sup>
Noise equivalent exposure	8.1 pJ/cm <sup>2</sup>
Amplifier sensitivity	6.6 $\mu\text{V}/\text{electron}$
Saturation output voltage	1100 mV
Saturation charge capacity	167,000 electrons
Charge Transfer Efficiency	>0.99995
Peak responsivity	41V/ $\mu\text{J}/\text{cm}^2$
PRNU	$\pm 5\%$
Dead pixels	0
Lag	1.5%
Spectral Response Range	200 nm to 1000 nm
Data Range	40 MHz

Notes:

1. Defined as  $Q_{sat}/\text{rms noise (total)}$

2. For illumination at 750 nm

# Linear Photodiode Diode Arrays

## Exposure Control and Antiblooming

An exposure control feature in the P-series imagers supports variable charge accumulation time in the photodiode. When the antiblooming gate voltage ( $\emptyset_{AB}$ ) is set to its high state, charge is drained from the pixel storage gate to the exposure control drain. During normal charge collection in the photodiode,  $\emptyset_{AB}$  is set to its low state. Due to the timing requirements of the exposure control mode, charge is always accumulated at the end of the period just before the charge is transferred to the readout register. Figure 3 includes the timing requirements for exposure control with the antiblooming gate. The exposure control timing shown will act on the charge packets that emerge as video data on the next readout cycle.

## Imager Performance

In P-series imagers each element performs its own function admirably while integrating smoothly with the other elements on the team. The photodiodes efficiently transform light to charge, the readout registers accurately transport the charge to the amplifier, and the amplifier delivers a clean, robust signal for use in image processing electronics. While the actual performance of these imagers depends strongly on the details of the electronics and timing the camera provides, their straight-forward implementation requirements facilitate optimum designs.

## Operating Conditions

For optimum performance and longest life, carefully follow the operational requirements of these imagers. Provide stable voltage sources free of noise and variation, and clean waveforms with controlled edges. Protect the imager from electrostatic discharge (ESD) and excessive voltages and temperatures. Do not violate the limits on output register speed or reduce timing margins below the minimums.

## Imager Configuration

All P-series imagers are constructed using ceramic packages and optically-flat windows. Imager die are secured to precision lead frames by thermal silver-filled epoxy. Packages are baked before sealing to eliminate moisture, and tested for seal integrity.

Table 4. Operating Voltages

Signal	Function	State	Voltage	Tolerance
$\emptyset_{H1}$ , $\emptyset_{H2}$	Horizontal Clocks	High Low	5 0	+5%
$\emptyset_{TG}$	Transfer Gate	High Low	8 0	$\pm 10\%$
$\emptyset_{PG}$	Photo Gate	High Low	8 -4	+5% $\pm 5\%$
$\emptyset_{AB}$	Antiblooming Gate	High Low	4 -4	+5% $\pm 5\%$
$V_{OG}$	Output Gate		3	$\pm 5\%$
$\emptyset_{RG}$	Reset Gate	High Low	8 0	$\pm 10\%$
$V_{DD}$	Amplifier Voltage Supply		12	$\pm 5\%$
$V_{RD}$	Amplifier Reset Drain		9.5	$\pm 5\%$
$V_{SS}$ / LS	Amplifier Return/Light Shield		0	

Table 5. Absolute Maximum Ratings (Above Which Useful Life May Be Impaired)

	Min	Max	Unit
<b>Temperature</b>			
Storage	-25	+85	$^{\circ}\text{C}$
Operating	-25	+55	$^{\circ}\text{C}$
<b>Voltage (with respect to GND)</b>			
Pins 3, 4, 17- 19	-0.3	+18	V
Pins 2, 10, 20	-0.3	+18	V
Pins 1, 11	-0.3	+ 0	V
Pins 15, 16	-4.3	+18	V

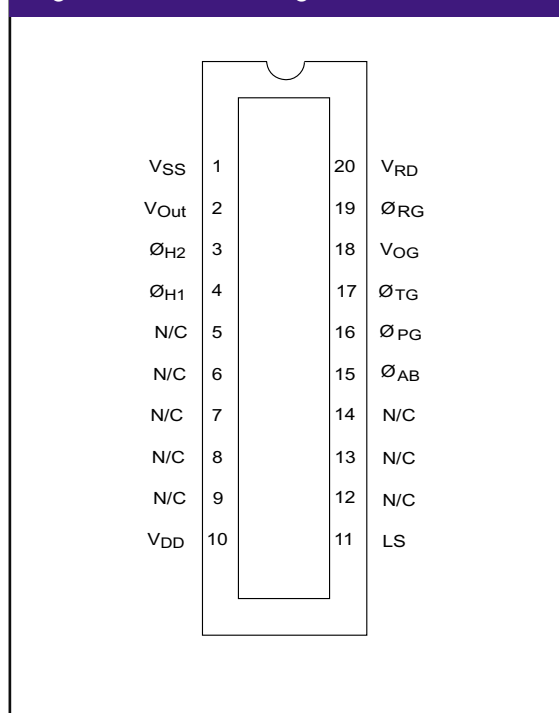
**Precautionary Note:** The CCD output pin (pin #2) must never be shorted to either  $V_{SS}$  or  $V_{DD}$  while power is applied to the device. Catastrophic device failure will result!

# Linear Photodiode Array Imagers

Table 6. Pinout Description and Capacitance Values

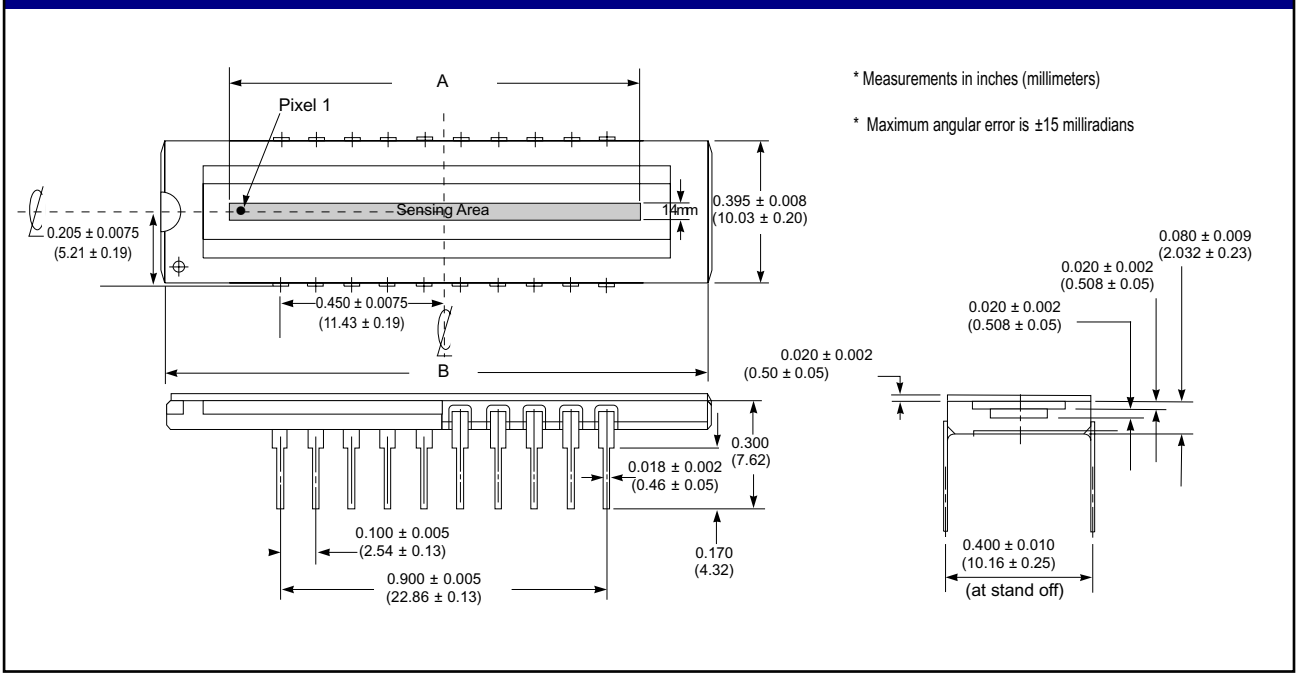
Pin	Sym	Function	Capacitance (pF) (typ)			
			Pixels	2048	1024	512
1	V <sub>SS</sub>	Amplifier return		50	30	20
2	V <sub>Out</sub>	Signal output		75	45	30
3	Ø <sub>H2</sub>	CCD horizontal phase 2		320	150	70
4	Ø <sub>H1</sub>	CCD horizontal phase 1		350	190	90
5	N/C	No connection				
6	N/C	No connection				
7	N/C	No connection				
8	N/C	No connection				
9	N/C	No connection				
10	V <sub>DD</sub>	Amplifier drain supply				
11	LS	Light shield				
12	N/C	No connection				
13	N/C	No connection				
14	N/C	No connection				
15	Ø <sub>AB</sub>	Antiblooming gate		70	35	20
16	Ø <sub>PG</sub>	Photo gate		100	50	25
17	Ø <sub>TG</sub>	Transfer gate		90	50	25
18	V <sub>OG</sub>	Output gate		8	8	8
19	Ø <sub>RG</sub>	Reset gate		7	2	2
20	V <sub>RD</sub>	Reset drain				

Figure 5. Pinout Configuration



# Linear Photodiode Array Imagers

Figure 6. Outline Drawings



## Ordering Information

The RL0512P, RL1024P, and RL2048P are available with either glass or fused silica windows. On special orders, PerkinElmer can supply anti-reflectance coated windows or windowless packages. Imagers are packed in electrostatic-resistant boxes and identified by lot numbers for tracking.

Table 7. Package Dimensions and Tolerances

Device	A		B	
	Inches	mm	Inches	mm
RL0512P	0.284	7.224	1.500 $\pm$ 0.15	38.1 $\pm$ 0.381
RL1024P	0.566	14.392	1.500 $\pm$ 0.15	38.1 $\pm$ 0.381
RL2048P	1.131	28.728	1.500 $\pm$ 0.15	38.1 $\pm$ 0.381

Notes: Includes active and transition pixels

Table 8. Stock Part Numbers

Window	Active Pixels		
	512	1024	2048
Glass	RL0512PAG-021	RL1024PAG-021	RL2048PAG-021
Fused Silica	RL0512PAQ-021	RL1024PAQ-021	RL2048PAQ-021

## Linear Photodiode Arrays Imagers

For more information, email us at  
[ccd@perkinelmer.com](mailto:ccd@perkinelmer.com), or visit our  
website at [www.perkinelmer.com/ccd](http://www.perkinelmer.com/ccd)

All values are nominal; specifications  
are subject to change without notice.

Table 9. Sales Offices

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